



BT150

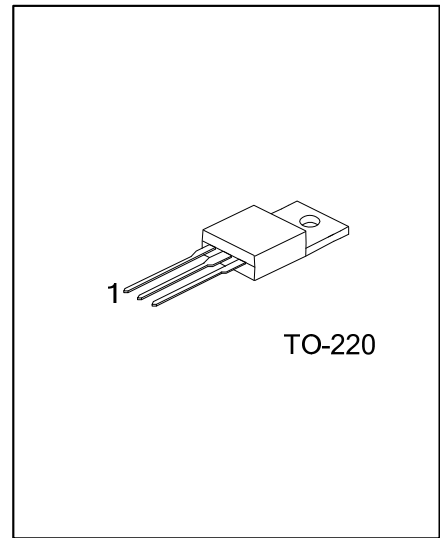
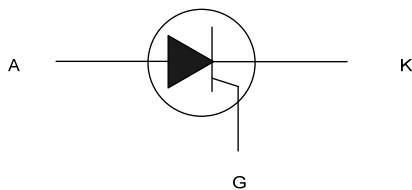
SCR

SCRS

DESCRIPTION

Passivated thyristors in a plastic envelope, intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. Typical applications include motor control, industrial and domestic lighting, heating and static switching.

SYMBOL



ORDERING INFORMATION

Order Number		Package	Pin Assignment			Packing
Lead Free Plating	Halogen Free		1	2	3	
BT150L-TA3-T	BT150G-TA3-T	TO-220	K	A	G	Tube

Note: Pin Assignment: K: Cathode A: Anode G: Gate

<p>BT150L-TA3-T</p> <p>(1)Packing Type</p> <p>(2)Package Type</p> <p>(3)Lead Free</p>	<p>(1) T: Tube</p> <p>(2) TA3: TO-220</p> <p>(3) G: Halogen Free, L: Lead Free</p>
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■ ABSOLUTE MAXIMUM RATING

PARAMETER	SYMBOL	RATINGS	UNIT	
Repetitive Peak Off-State Voltages	V_{DRM} V_{RRM}	500(Note1)	V	
		650(Note1)		
		800		
Average On-State Current (half sine wave; $T_A \leq 113^\circ\text{C}$)	$I_{T(AV)}$	2.5	A	
RMS on-State Current (all conduction angles)	$I_{T(RMS)}$	4	A	
Non-Repetitive Peak On-State Current (half sine wave; $T_J = 25^\circ\text{C}$ prior to surge)	I_{TSM}	t=10ms	35	A
		t=8.3ms	38	
I^2t for Fusing (t = 10 ms)	I^2t	6.1	A^2s	
Repetitive Rate of Rise of On-State Current After Triggering ($I_{TM} = 10\text{ A}$; $I_G = 50\text{ mA}$; $dI_G/dt = 50\text{ mA/ms}$)	dI_T/dt	50	$\text{A}/\mu\text{s}$	
Peak Gate Current	I_{GM}	2	A	
Peak Gate Voltage	V_{GM}	5	V	
Peak Reverse Gate Voltage	V_{RGM}	5	V	
Peak Gate Power (over any 20 ms period)	P_{GM}	5	W	
Average Gate Power	$P_{G(AV)}$	0.5	W	
Operating Junction Temperature	T_J	125 (Note2)	$^\circ\text{C}$	
Storage Temperature	T_{stg}	-40 ~150	$^\circ\text{C}$	

Note 1. Although not recommended, off-state voltages up to 800V may be applied without damage, but the thyristor may switch to the on-state. The rate of rise of current should not exceed $15\text{ A}/\mu\text{s}$.

2. Operation above 110°C may require the use of a gate to cathode resistor of $1\text{ k}\Omega$ or less.

3. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL RESISTANCES

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT
Junction to Ambient	θ_{JA}		60		K/W
Junction to Base	θ_{JB}			2.5	K/W

■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNIT
Gate Trigger Current	I_{GT}	$V_D=12\text{V}$, $I_T=0.1\text{A}$		15	200	μA
Latching Current	I_L	$V_D=12\text{V}$, $I_{GT}=0.1\text{A}$		0.17	10	mA
Holding Current	I_H	$V_D=12\text{V}$, $I_{GT}=0.1\text{A}$		0.10	6	mA
On-State Voltage	V_T	$I_T=5\text{A}$		1.23	1.8	V
Gate Trigger Voltage	V_{GT}	$V_D=12\text{V}$, $I_T=0.1\text{A}$ $V_D=V_{DRM(max)}$, $I_T=0.1\text{A}$, $T_J=110^\circ\text{C}$	0.1	0.4 0.2	1.5	V
Off-State Leakage Current	I_D , I_R	$V_D=V_{DRM(max)}$, $V_R=V_{RRM(max)}$, $T_J=125^\circ\text{C}$		0.1	0.5	mA
Critical Rate of Rise of Off-State Voltage	dV_D/dt	$V_{DM}=67\%V_{DRM(max)}$, $T_J=125^\circ\text{C}$, exponential waveform; $R_{GK}=100\Omega$		50		$\text{V}/\mu\text{s}$
Gate Controlled Turn-on Time	t_{gt}	$I_{TM}=10\text{A}$, $V_D=V_{DRM(max)}$, $I_G=5\text{mA}$, $dI_G/dt=0.2\text{ A}/\mu\text{s}$		2		μs
Circuit Commutated Turn-off time	t_q	$V_D=67\%V_{DRM(max)}$, $T_J=125^\circ\text{C}$, $I_{TM}=8\text{A}$, $V_R=25\text{V}$, $dI_{TM}/dt=10\text{ A}/\mu\text{s}$, $dV_D/dt=2\text{ V}/\mu\text{s}$, $R_{GK}=1\text{ k}\Omega$		100		μs

■ TYPICAL CHARACTERISTICS

Fig 1. Maximum On-State Dissipation, p_{tot} , Versus Average On-State Current, $I_{T(AV)}$, Where $a = \text{form factor} = I_{T(RMS)} / I_{T(AV)}$

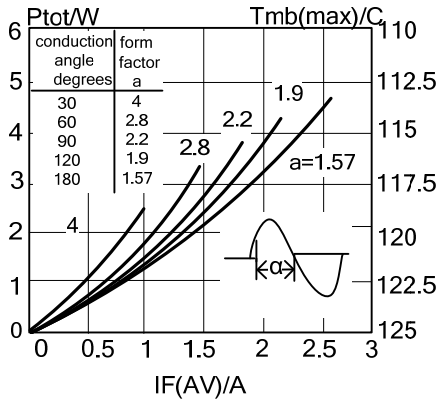


Fig 2. Maximum Permissible Non-Repetitive Peak On-State Current I_{TSM} , Versus Pulse Width t_p for Sinusoidal Currents, $t_p \ll 10\text{ms}$

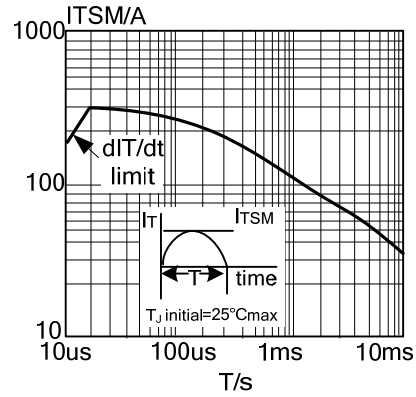


Fig 3. Maximum Permissible Rms Current $I_T(RMS)$, Versus Mounting Base Temperature T_{mb}

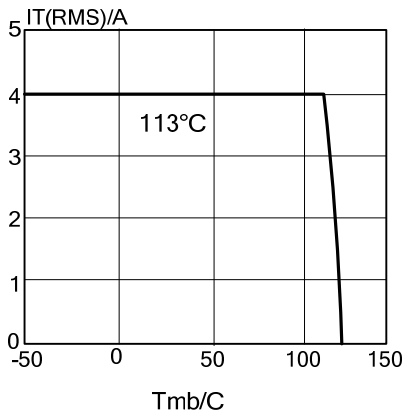


Fig 4. Maximum Permissible Non-Repetitive Peak On-State Current I_{TSM} , Versus Number Of Cycles, For Sinusoidal Currents, $f=50\text{Hz}$

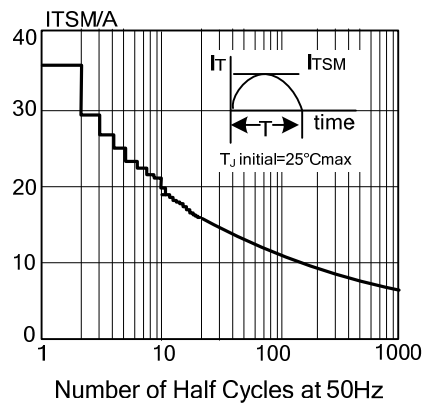


Fig 5. Maximum Permissible Repetitive Rms On-State Current $I_T(RMS)$, Versus Surge Duration, For Sinusoidal Currents, $f=50\text{Hz}$; $T_{mb} \leq 113^\circ\text{C}$

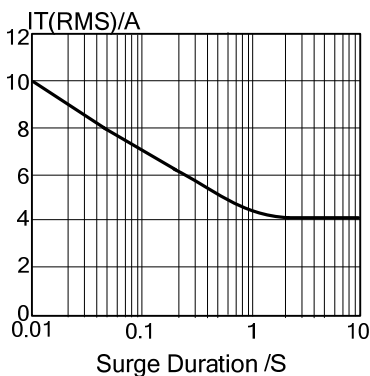
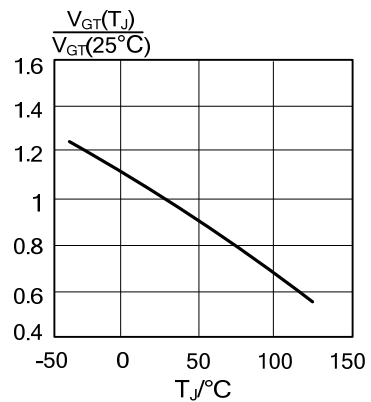


Fig 6. Normalised Gate Trigger Voltage $V_{GT}(T_J) / V_{GT}(25^\circ\text{C})$, Versus Junction Temperature T_J



■ TYPICAL CHARACTERISTICS(Cont.)

Fig 7. Normalised Gate Trigger Current $I_{GT}(T_J)/I_{GT}(25^\circ\text{C})$, Versus Junction Temperature T_J

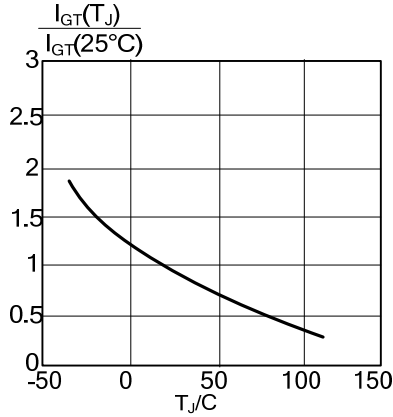


Fig 8. Normalised Latching Current $I_L(T_J)/I_L(25^\circ\text{C})$, Versus Junction Temperature T_J

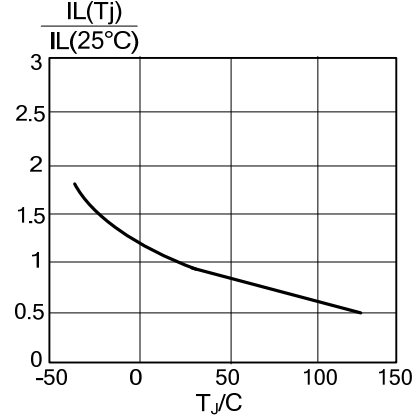


Fig 9. Normalised Holding Current $I_H(T_J)/I_H(25^\circ\text{C})$, Versus Junction Temperature T_J

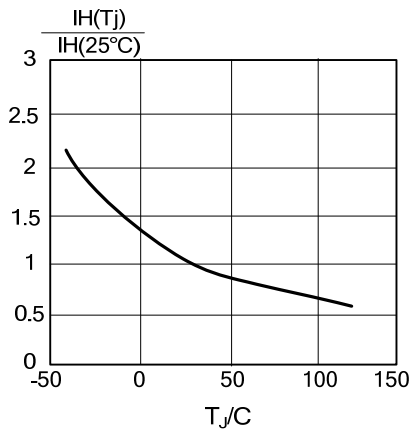


Fig 10. Typical and Maximum On-State Characteristic

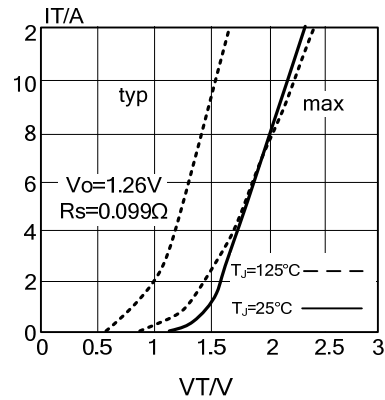


Fig 11. Transient Thermal Impedance Z_{thj-mb} , Versus Pulse Width t_p

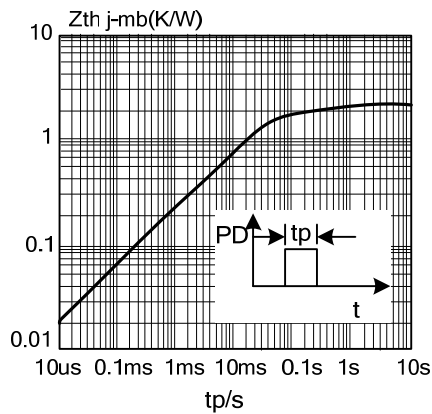
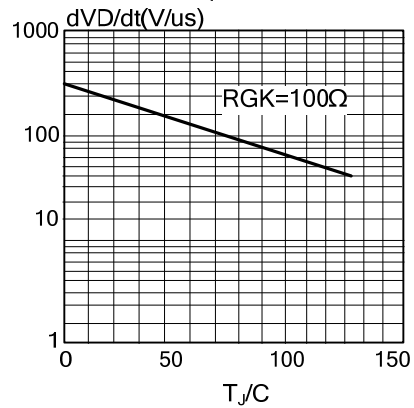


Fig 12. Typical, Critical Rate Of Rise Of Off-State Voltage, dV_D/dt Versus Junction Temperature T_J



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